32-bit edge-triggered D-type flip-flop with 5 V tolerant inputs/outputs; 3-state

Rev. 3 — 18 December 2012

**Product data sheet** 

## 1. General description

The 74LVCH32374A is a 32-bit edge-triggered flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus oriented applications. The device consists of 4 sections of 8 edge-triggered flip-flops. A clock (pin nCP) input and an output enable input (pin nOE) are provided per 8-bit section. The flip-flops will store the state of their individual D-inputs that meet the set-up and hold time requirements on the LOW-to-HIGH nCP transition. When pin nOE is LOW, the contents of the flip-flops are available at the outputs. When pin nOE is HIGH, the outputs go to the high-impedance OFF-state. Operation of pin nOE does not affect the state of the flip-flops. The inputs can be driven from either 3.3 V or 5 V devices. In 3-state operation, the outputs can handle 5 V. These features allow the use of these devices in a mixed 3.3 V or 5 V environment.

Bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

## 2. Features and benefits

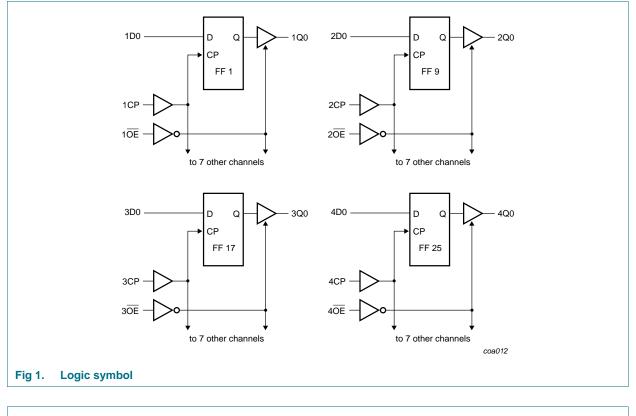
- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pin-out architecture
- Multiple low inductance supply pins for minimum noise and ground bounce
- Direct interface with TTL levels
- All data inputs have bus hold
- High impedance when V<sub>CC</sub> = 0 V
- Latch-up performance exceeds 500 mA per JESD 78 Class II
- Complies with JEDEC standard:
  - JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Packaged in plastic fine-pitch ball grid array package

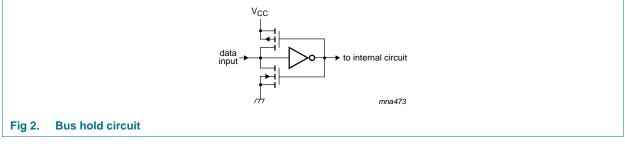


## 3. Ordering information

Table 1. Ordering	g information			
Type number	Package			
	Temperature range	Name	Description	Version
74LVCH32374AEC	–40 °C to +125 °C	LFBGA96	plastic low profile fine-pitch ball grid array package; 96 balls; body $13.5 \times 5.5 \times 1.05$ mm	SOT536-1

# 4. Functional diagram





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## 5. Pinning information

## 5.1 Pinning

																001	aah180
	6	1D1	1D3	1D5	1D7	2D1	2D3	2D5	2D6	3D1	3D3	3D5	3D7	4D1	4D3	4D5	4D6
	5	1D0	1D2	1D4	1D6	2D0	2D2	2D4	2D7	3D0	3D2	3D4	3D6	4D0	4D2	4D4	4D7
	4	1CP	GND	V <sub>CC</sub>	GND	GND	Vcc	GND	2CP	3CP	GND	Vcc	GND	GND	Vcc	GND	4CP
	3	10E	GND	V <sub>CC</sub>	GND	GND	V <sub>CC</sub>	GND	2 <del>0E</del>	3 <del>0E</del>	GND	V <sub>CC</sub>	GND	GND	V <sub>CC</sub>	GND	4 <del>0E</del>
	2	1Q0	1Q2	1Q4	1Q6	2Q0	2Q2	2Q4	2Q7	3Q0	3Q2	3Q4	3Q6	4Q0	4Q2	4Q4	4Q7
	1	1Q1	1Q3	1Q5	1Q7	2Q1	2Q3	2Q5	2Q6	3Q1	3Q3	3Q5	3Q7	4Q1	4Q3	4Q5	4Q6
		А	в	С	D	Е	F	G	н	J	к	L	М	Ν	Ρ	R	т
Fig 3.	Pin configur	ation	1														

## 5.2 Pin description

### Table 2. Pin description

Symbol	Ball	Description
$n\overline{OE}$ (n = 1 to 4)	A3, H3, J3, T3	output enable input (active LOW)
nCP (n = 1 to 4)	A4, H4, J4, T4	clock input
1D[0:7]	A5, A6, B5, B6, C5, C6, D5, D6	data input
2D[0:7]	E5, E6, F5, F6, G5, G6, H6, H5	data input
3D[0:7]	J5, J6, K5, K6, L5, L6, M5, M6	data input
4D[0:7]	N5, N6, P5, P6, R5, R6, T6, T5	data input
1Q[0:7]	A2, A1, B2, B1, C2, C1, D2, D1	data output
2Q[0:7]	E2, E1, F2, F1, G2, G1, H1, H2	data output
3Q[0:7]	J2, J1, K2, K1, L2, L1, M2, M1	data output
4Q[0:7]	N2, N1, P2, P1, R2, R1, T1, T2	data output
GND	B3, B4, D3, D4, E3, E4, G3, G4, K3, K4, M3, M4, N3, N4, R3, R4	ground (0 V)
V <sub>CC</sub>	C3, C4, F3, F4, L3, L4, P3, P4	supply voltage

## 6. Functional description

Table 3.	Function table <sup>[1]</sup>	

Operating mode	Input				op Output
	nOE	nCP	nDn		nQn
Load and read	L	$\uparrow$	I	L	L
register	L	$\uparrow$	h	Н	Н
Load register and	Н	$\uparrow$	I	L	Z
disable outputs	Н	$\uparrow$	h	Н	Z

[1] H = HIGH voltage level

L = LOW voltage level

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW CP transition

I = LOW voltage level one set-up time prior to the HIGH-to-LOW CP transition

Z = high-impedance OFF-state

 $\uparrow$  = LOW-to-HIGH CP transition

## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground =  $0 V)^{[1]}$ 

				10	
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0	-50	-	mA
VI	input voltage		<u>[2]</u> –0.5	+6.5	V
Ι <sub>ΟΚ</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0	-	±50	mA
Vo	output voltage	output HIGH or LOW state	<u>[3]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[3]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	200	mA
I <sub>GND</sub>	ground current		-200	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb}$ = -40 °C to +125 °C	<u>[4]</u> _	1000	mW

[1] All supply and ground pins connected externally to one voltage source.

[2] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[3] The output voltage ratings may be exceeded if the output current ratings are observed.

[4] Above 70 °C the value of P<sub>tot</sub> derate linearly with 1.8 mW/K.

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# 8. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Symbol	i arameter	Conditions	NVIII I	тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V <sub>CC</sub>	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	-	-	20	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	10	ns/V

## 9. Static characteristics

### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +	85 °C	–40 °C to	o +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
VIH	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC}$ = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
VIL	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35\times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC}$ = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>ОН</sub>	HIGH-level	$V_I = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$		-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_O = -8$ mA; $V_{CC} = 2.3$ V	1.8	-	-	1.65	-	V
		$I_{O}$ = -12 mA; $V_{CC}$ = 2.7 V	2.2	-	-	2.05	-	V
		$I_{O}$ = -18 mA; $V_{CC}$ = 3.0 V	2.4	-	-	2.25	-	V
		$I_{O}$ = -24 mA; $V_{CC}$ = 3.0 V	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH} \text{ or } V_{IL}$						
	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_0$ = 12 mA; $V_{CC}$ = 2.7 V	-	-	0.4	-	0.6	V
		$I_{O}$ = 24 mA; $V_{CC}$ = 3.0 V	-	-	0.55	-	0.8	V
I	input leakage current	V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V or GND <sup>[2]</sup>	-	±0.1	±5	-	±20	μΑ
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### **NXP Semiconductors**

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### 32-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state

Symbol	Parameter	Conditions		–40 °C to +	-85 °C	–40 °C	to +125 °C	Unit
			М	in Typ <mark>[1</mark>	Max	Min	Max	
l <sub>oz</sub>	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};$ $V_{O} = 5.5 \text{ V or } \text{GND}^{[2]}$	-	±0.1	±5	-	±20	μA
OFF	power-off leakage current	$V_{CC}$ = 0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V	-	±0.1	±10	-	±20	μA
I <sub>CC</sub>	supply current	$V_{CC} = 3.6 \text{ V};$ $V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A}$	-	0.1	40	-	160	μA
∆l <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μA
Cı	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>	-	5.0	-	-	-	pF
BHL	bus hold LOW	$V_{CC} = 1.65; V_I = 0.58 V_{[3][4]}$	1	0 -	-	10	-	μA
	current	$V_{CC} = 2.3; V_I = 0.7 V$	3	0 -	-	25	-	μA
		$V_{CC} = 3.0; V_I = 0.8 V$	7	5 -	-	60	-	μΑ
внн	bus hold HIGH	V <sub>CC</sub> = 1.65; V <sub>I</sub> = 1.07 V <sup>[3][4]</sup>	-1	0 -	-	-10	-	μA
	current	$V_{CC} = 2.3; V_I = 1.7 V$	-3	- 00	-	-25	-	μA
		$V_{CC} = 3.0; V_{I} = 2.0 V$	-7	'5 -	-	-60	-	μA
BHLO	bus hold LOW	V <sub>CC</sub> = 1.95 V <u>[3][5]</u>	20	- 00	-	200	-	μA
	overdrive current	V <sub>CC</sub> = 2.7 V	30	- 00	-	300	-	μΑ
	Current	V <sub>CC</sub> = 3.6 V	50	- 00	-	500	-	μA
BHHO	bus hold HIGH	V <sub>CC</sub> = 1.95 V <sup>[3][5]</sup>	-2	- 00	-	-200	-	μA
	overdrive	V <sub>CC</sub> = 2.7 V	-3	- 00	-	-300	-	μA
	current	V <sub>CC</sub> = 3.6 V	-5	- 00	-	-500	-	μA

### Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C.

[2] The bus hold circuit is switched off when V<sub>I</sub> > V<sub>CC</sub> allowing 5.5 V on the input pin.

[3] Valid for data inputs only. Control inputs do not have a bus hold circuit.

[4] The specified sustaining current at the data input holds the input below the specified V<sub>1</sub> level.

[5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

## **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	o +125 ℃	Unit
			-	Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub>	propagation	nCP to nQn; see Figure 4	[2]					1	
	delay	V <sub>CC</sub> = 1.2 V		-	14	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.1	6.9	13.5	2.1	15.6	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	3.7	6.7	1.5	7.7	ns
		$V_{CC} = 2.7 V$		1.5	3.4	6.0	1.5	7.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.5	3.1	5.4	1.5	7.0	ns
t <sub>en</sub>	enable time	nOE to nQn; see <u>Figure 6</u>	[2]						
		V <sub>CC</sub> = 1.2 V		-	20	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.5	5.9	13.1	1.5	15.1	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	3.4	6.9	1.5	8.0	ns
		$V_{CC} = 2.7 V$		1.5	3.6	6.0	1.5	7.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.7	5.2	1.0	6.5	ns
t <sub>dis</sub>	disable time	nOE to nQn; see Figure 4	[2]						
		V <sub>CC</sub> = 1.2 V		-	12	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		2.8	4.6	9.1	2.8	10.5	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.5	4.9	1.0	5.7	ns
		$V_{CC} = 2.7 V$		1.5	3.4	5.1	1.5	6.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.5	3.1	4.9	1.5	6.5	ns
t <sub>W</sub>	pulse width	nCP HIGH; see Figure 4							
		$V_{CC}$ = 1.65 V to 1.95 V		5.0	-	-	5.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.0	-	-	3.0	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V		3.0	1.5	-	3.0	-	ns
t <sub>su</sub>	set-up time	nDn to nCP; see Figure 5							
		$V_{CC}$ = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		3.0	-	-	3.0	-	ns
		$V_{CC} = 2.7 V$		1.9	-	-	1.9	-	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.9	0.3	-	1.9	-	ns
t <sub>h</sub>	hold time	nDn to nCP; see <u>Figure 5</u>							
		$V_{CC}$ = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		1.1	-	-	1.1	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	-0.3	-	1.5	-	ns

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### 32-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state

Symbol	Parameter	Conditions	Conditions		°C to +8	5 °C	-40 °C te	Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
f <sub>max</sub>	maximum	see Figure 4							
	frequency	$V_{CC}$ = 1.65 V to 1.95 V		100	-	-	80	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		125	-	-	100	-	ns
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	300	-	120	-	MHz
t <sub>sk(o)</sub>	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[3]</u>	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power	per input; $V_I = GND$ to $V_{CC}$	<u>[4]</u>						
	dissipation	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		-	14.1	-	-	-	pF
	capacitance	$V_{CC}$ = 2.3 V to 2.7 V		-	16.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	18.5	-	-	-	pF

### Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 7</u>.

[1] Typical values are measured at  $T_{amb} = 25$  °C and  $V_{CC} = 1.2$  V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

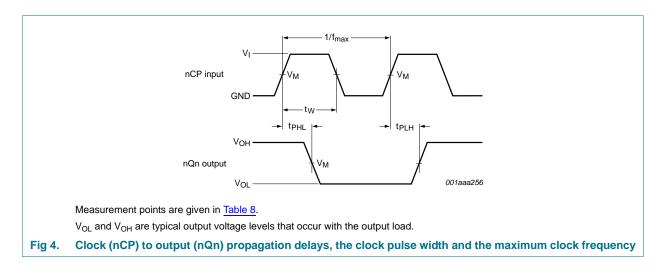
 $C_L$  = output load capacitance in pF

 $V_{CC}$  = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs

## 11. Waveforms

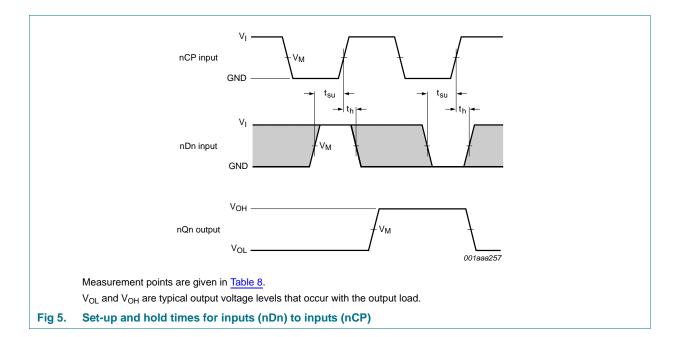


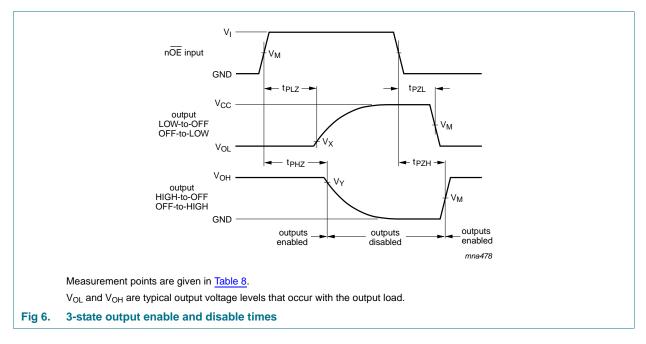
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# 74LVCH32374A

#### 32-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state



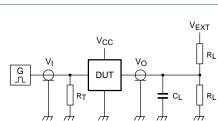


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### 32-bit edge-triggered D-type flip-flop; 5 V tolerant; 3-state

Supply voltage	Input		Output						
V <sub>cc</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>				
1.2 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5  imes V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V				
1.65 V to 1.95 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	$V_{OH} - 0.15 \ V$				
2.3 V to 2.7 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	$V_{OH} - 0.15 \ V$				
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \; V$				
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V				





Test data is given in <u>Table 9</u>. Definitions for test circuit:

R<sub>L</sub> = Load resistance

 $C_L$  = Load capacitance including jig and probe capacitance

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator

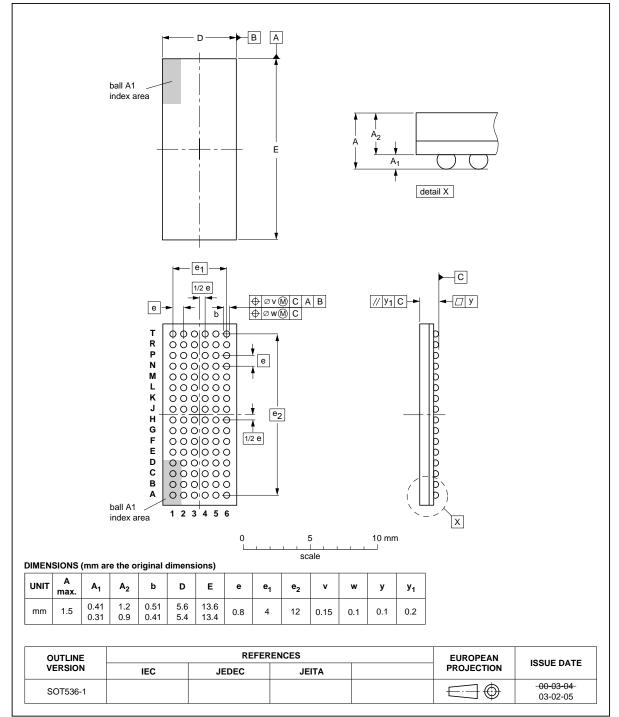
Fig 7. Load circuitry for switching times

### Table 9. Test data

Input		Load		V <sub>EXT</sub>		
VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>
V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND
V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND
V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND
2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND
2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND
	Vi           Vcc           Vcc           Vcc           2.7 V	$V_I$ $t_r, t_f$ $V_{CC}$ $\leq 2 \text{ ns}$ $V_{CC}$ $\leq 2 \text{ ns}$ $V_{CC}$ $\leq 2 \text{ ns}$ $2.7 \text{ V}$ $\leq 2.5 \text{ ns}$	$t_r, t_f$ $C_L$ $V_{CC}$ $\leq 2 \text{ ns}$ $30 \text{ pF}$ $2.7 \text{ V}$ $\leq 2.5 \text{ ns}$ $50 \text{ pF}$	$V_I$ $t_r, t_f$ $C_L$ $R_L$ $V_{CC}$ $\leq 2$ ns         30 pF         1 kΩ $V_{CC}$ $\leq 2$ ns         30 pF         1 kΩ $V_{CC}$ $\leq 2$ ns         30 pF         500 Ω           2.7 V $\leq 2.5$ ns         50 pF         500 Ω	VI         tr, tf         CL         RL         tPLH, tPHL           V <sub>CC</sub> $\leq$ 2 ns         30 pF         1 kΩ         open           V <sub>CC</sub> $\leq$ 2 ns         30 pF         1 kΩ         open           V <sub>CC</sub> $\leq$ 2 ns         30 pF         1 kΩ         open           V <sub>CC</sub> $\leq$ 2 ns         30 pF         500 Ω         open           V <sub>CC</sub> $\leq$ 2 ns         50 pF         500 Ω         open	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $

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## 12. Package outline



LFBGA96: plastic low profile fine-pitch ball grid array package; 96 balls; body 13.5 x 5.5 x 1.05 mm SOT536-1

#### Fig 8. Package outline SOT536-1 (LFBGA96)

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# **13. Abbreviations**

	Table 10. Abbreviations		
Acronym	Description		
CDM	Charged Device Model		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

## 14. Revision history

# Table 11. Revision history Document ID Release date

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVCH32374A v.3	20121218	Product data sheet	-	74LVCH32374A v.2	
Modifications:	<ul> <li>The format of the of NXP Semicor</li> </ul>	his data sheet has been red onductors.	esigned to comply with	the new identity guidelines	
	<ul> <li>Legal texts hav</li> </ul>	e been adapted to the new	company name where	appropriate.	
	<ul> <li><u>Table 4</u>, <u>Table 5</u>, <u>Table 6</u>, <u>Table 7</u>, <u>Table 8</u> and <u>Table 9</u>: values added for lower voltage ranges.</li> </ul>				
74LVCH32374A v.2	20040519	Product specification	-	74LVCH32374A v.1	
74LVCH32374A v.1	19991124	Product specification	-	-	

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## **15. Legal information**

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 18 December 2012 Document identifier: 74LVCH32374A